

SEMICONDUCTOR DEVICES

Introduction to Semiconductors



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 - high-efficiency solar cells

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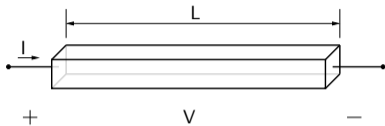
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- 88 MHz to 108 MHz: FM radio frequency range

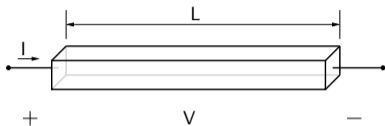
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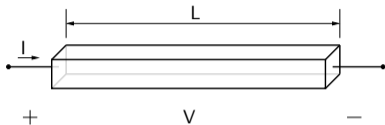
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- ~ 900 MHz: frequency for mobile communication (GSM standard)



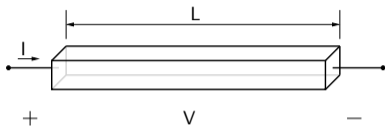


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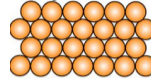
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Material	Type	$\sigma (\Omega\text{-cm})^{-1}$
Copper	conductor	$\sim 6 \times 10^5$
Glass	insulator	10^{-17} to 10^{-13}
Silicon	semiconductor	$\sim 10^{-5}$

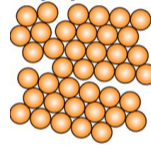
Solids may be classified as

- * Crystalline: Atoms are arranged in a periodic manner.

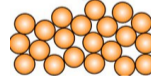
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Polycrystalline



Amorphous

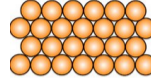


(Ref.: wikipedia)

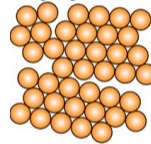
Solids may be classified as

- * Crystalline: Atoms are arranged in a periodic manner.
- * Polycrystalline: The solid contains many crystallites which vary in size and orientation.

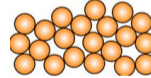
Crystalline



Polycrystalline



Amorphous

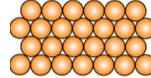


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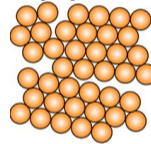
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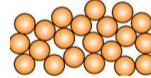
Crystalline



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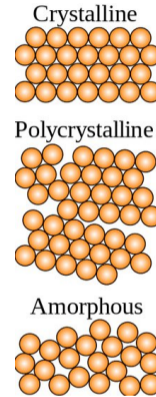


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Crystalline semiconductors have superior material properties, leading to higher device performance.



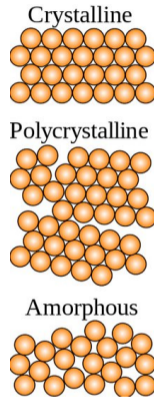
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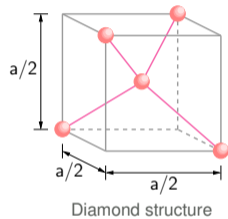
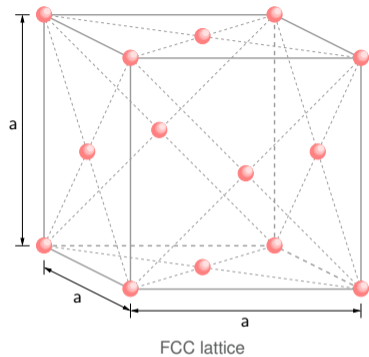
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Polycrystalline and amorphous semiconductors have relatively poor properties, but the ease of manufacturing and low cost makes them attractive for certain applications. e.g., as solar cells, thin-film transistors for display devices.



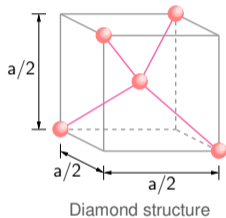
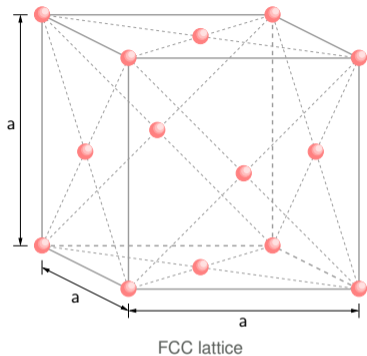
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Crystal structure of Si and GaAs



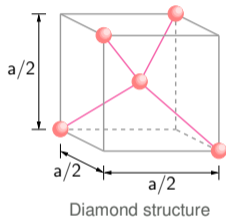
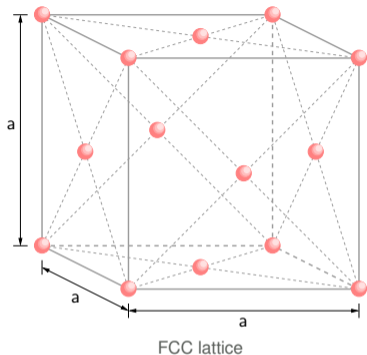
* Si and GaAs have the diamond structure.

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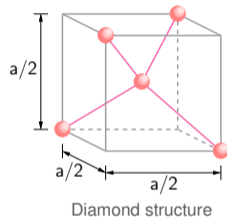
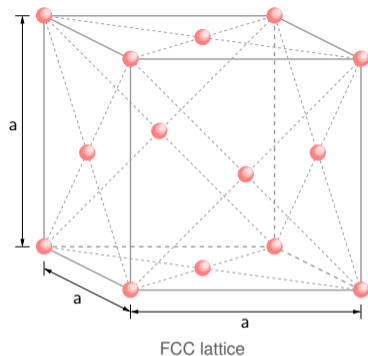
- * Si and GaAs have the diamond structure.
- * There are two identical FCC lattices, with lattice 2 displaced with respect to lattice 1 by one-fourth of the body diagonal.

Crystal structure of Si and GaAs



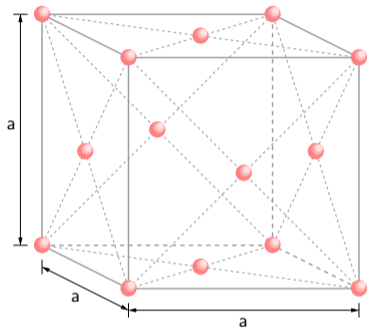
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Crystal structure of Si and GaAs

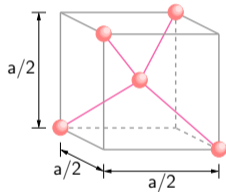


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- * The structure of GaAs is similar. Each Ga atom has four As neighbours, and *vice versa*.

Crystal structure of Si and GaAs

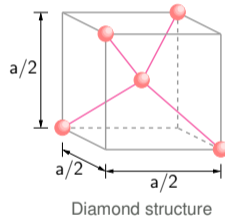
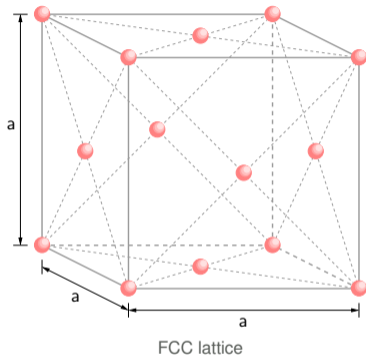


FCC lattice



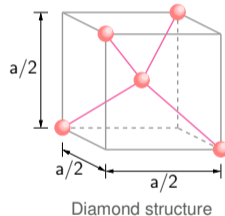
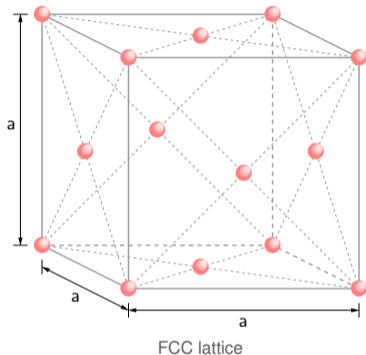
Diamond structure

Crystal structure of Si and GaAs



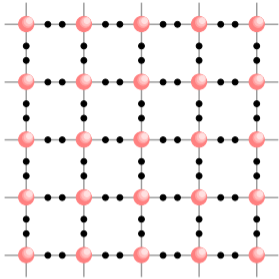
* In silicon, the distance between neighbouring atoms is $\sqrt{3} a/4$, with $a = 5.43 \text{ \AA}$.

Crystal structure of Si and GaAs



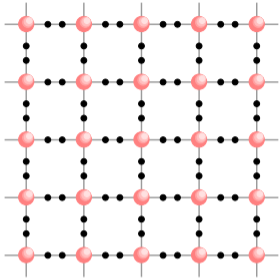
- * In silicon, the distance between neighbouring atoms is $\sqrt{3} a/4$, with $a = 5.43 \text{ \AA}$.
- * There are 5×10^{22} atoms per cm^3 .

Electrons and holes: the bond picture



2-D representation of silicon lattice

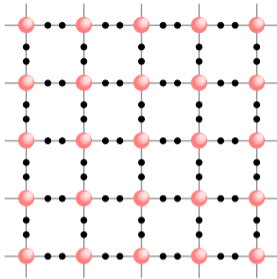
Electrons and holes: the bond picture



2-D representation of silicon lattice

- * Each silicon atom has a “core” part (nucleus + core electrons), and four “valence” electrons.

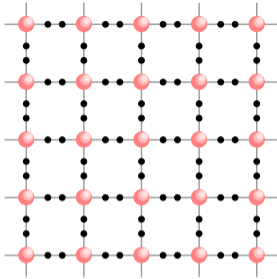
Electrons and holes: the bond picture



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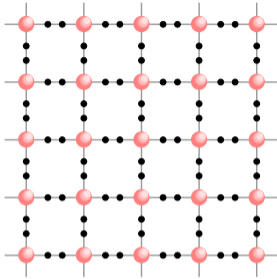
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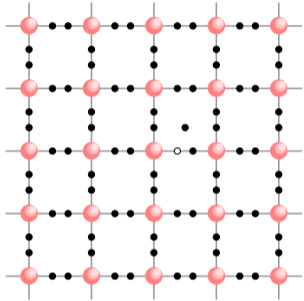
Electrons and holes: the bond picture



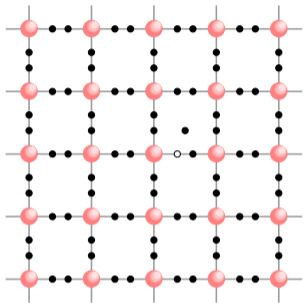
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- * At 0 K, all valence electrons are held by the covalent bonds, no electrons are available for conduction, and the material behaves like an insulator.

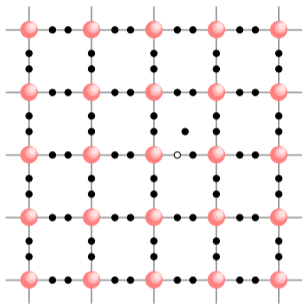
Electrons and holes: the bond picture



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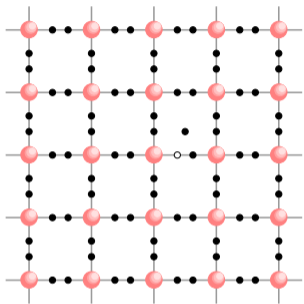


- * A small fraction of the valence electrons (about 10^{10} cm^{-3} or one per 5×10^{12} atoms at 300 K) have enough energy to break free from the bonds.



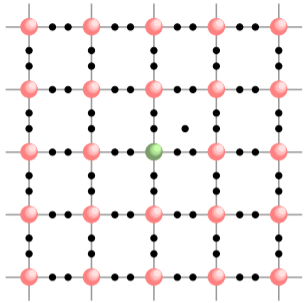
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Electrons and holes: the bond picture



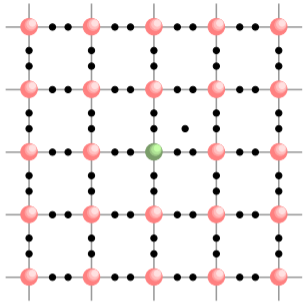
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- * These free electrons and holes are available for conduction.

Electrons and holes: the bond picture



Suppose one of the silicon atoms is replaced with a group V atom (e.g., P or As).

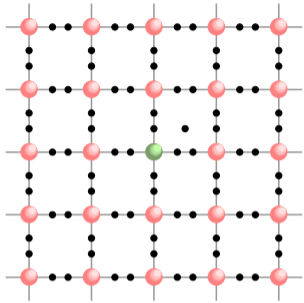
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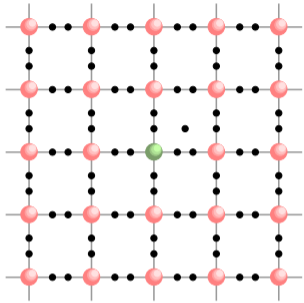
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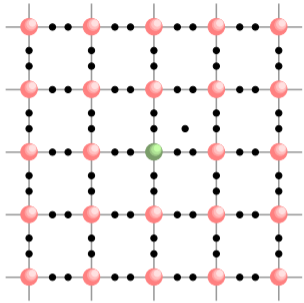
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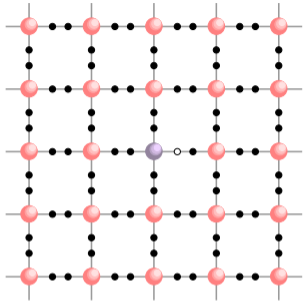
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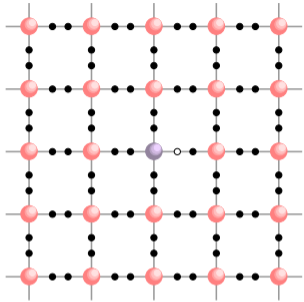
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- * We say that the group V atom has “donated” a free electron to the lattice which is available for conduction.

Electrons and holes: the bond picture



Suppose one of the silicon atoms is replaced with a group III atom (e.g., B).

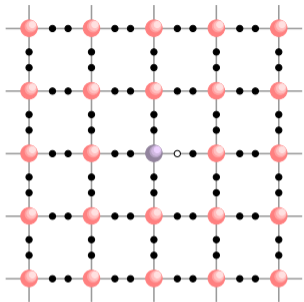
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Suppose one of the silicon atoms is replaced with a group III atom (e.g., B).

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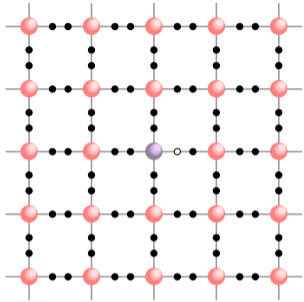
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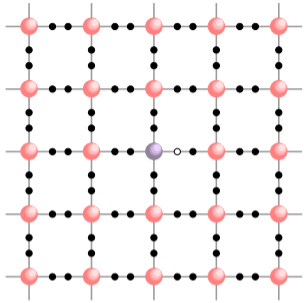
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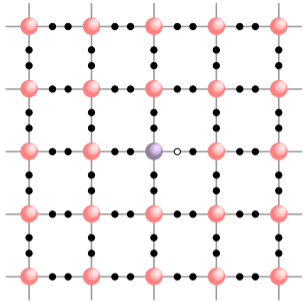
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- * We say that the group III atom has “accepted” an electron from a Si-Si bond, which is equivalent to transferring the vacancy (hole) to that bond.

The bond picture of a semiconductor gives us some insight, but it leaves several questions unanswered.

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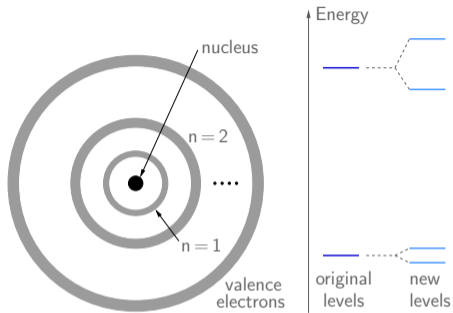
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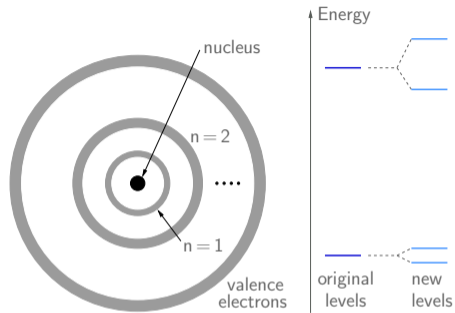
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- * What makes a crystalline material a semiconductor (and not a metal or an insulator)?
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- * How are the carriers distributed in energy?
- * Can *any* group V atom serve as a donor in silicon?

Electrons and holes: the band picture

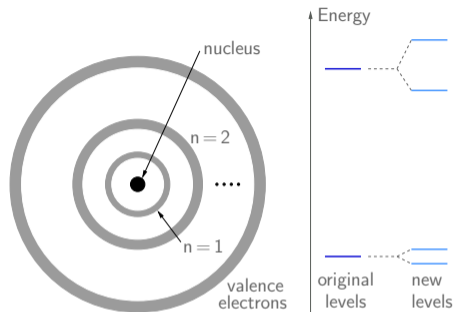


Electrons and holes: the band picture



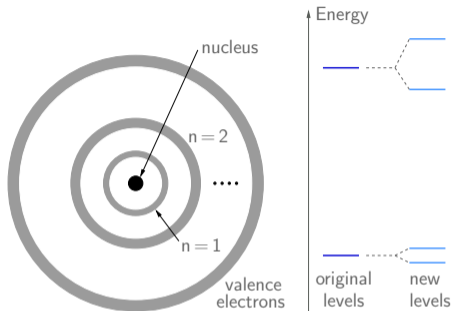
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Electrons and holes: the band picture



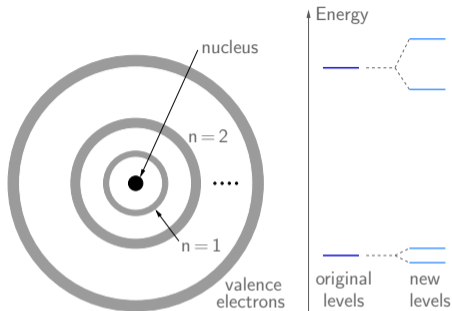
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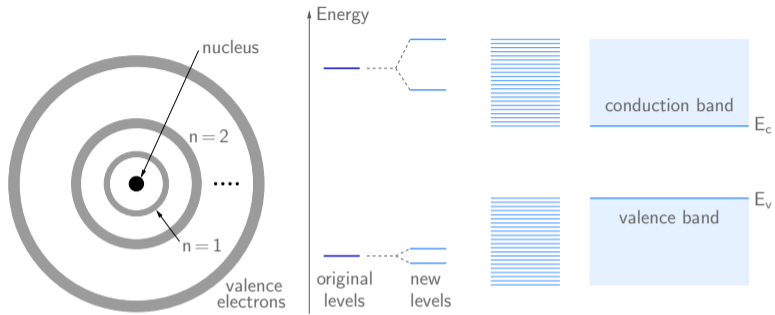
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Electrons and holes: the band picture

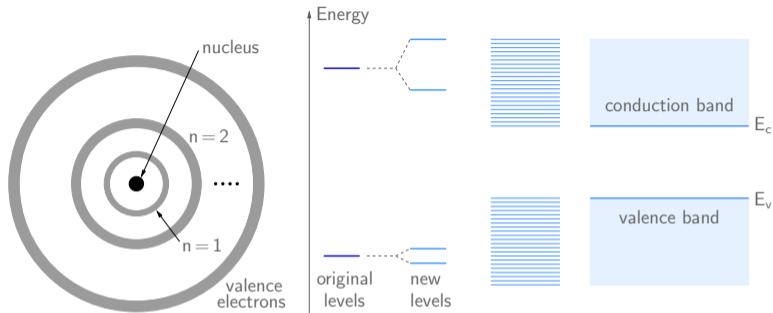


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- * Each of the energy level splits into two levels (states).

Electrons and holes: the band picture

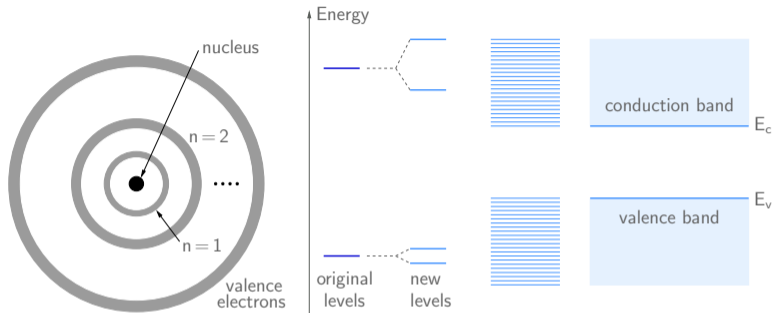


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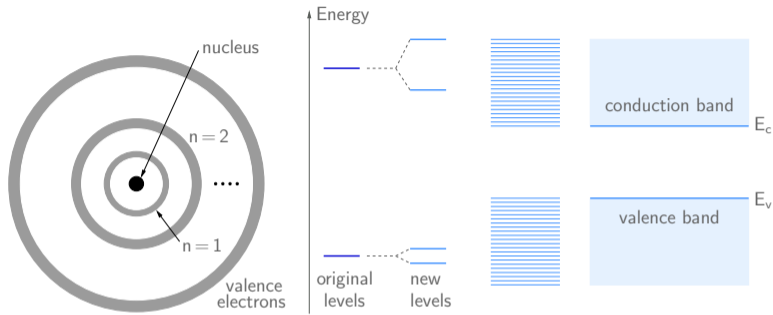
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Electrons and holes: the band picture



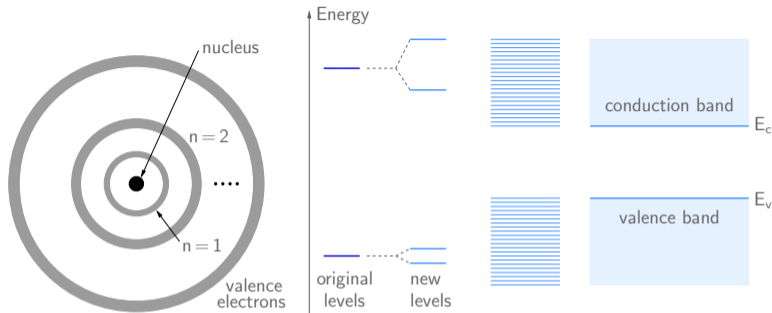
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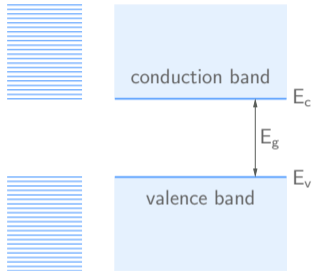
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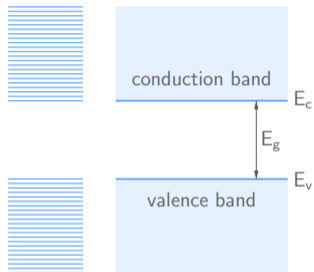
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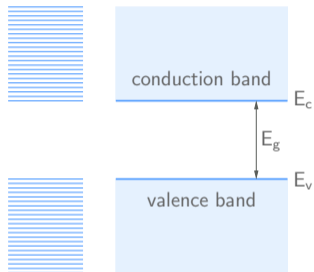
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- * The number of levels is so large that we can treat them as a *continuum* or "band" of levels (states).
- * For semiconductors, the states get bunched such that, in a certain energy range, $E_v < E < E_c$, there are no states at all.

Electrons and holes: the band picture

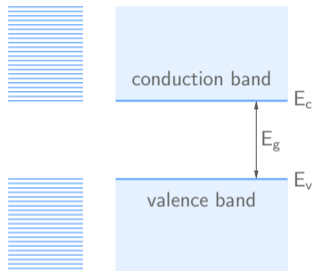




- * The bottom edge of the conduction band is denoted by E_c , and the top edge of the valence band by E_v .



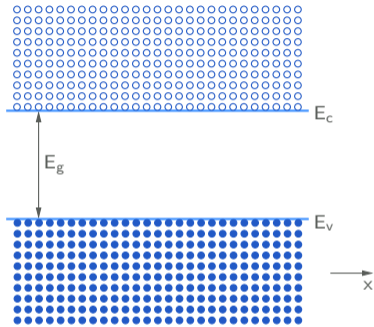
- * The bottom edge of the conduction band is denoted by E_c , and the top edge of the valence band by E_v .
- * The difference $E_c - E_v$ is called the “energy gap” (E_g), and it plays a fundamental role in the electrical and optical properties of a semiconductor.



Semiconductor	E_g (eV)
Ge	0.67
Si	1.1
GaAs	1.43
GaP	2.26
GaN	3.4

- * The bottom edge of the conduction band is denoted by E_c , and the top edge of the valence band by E_v .
- * The difference $E_c - E_v$ is called the “energy gap” (E_g), and it plays a fundamental role in the electrical and optical properties of a semiconductor.

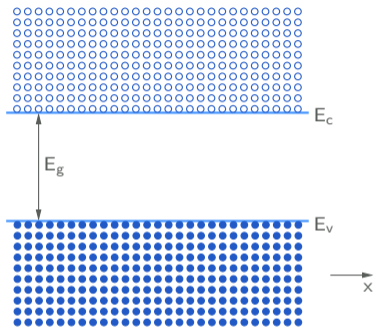
Electrons and holes: the band picture



Filled and empty electron states at 0 K.

(Note: This is a schematic representation;
in reality, the density of states varies with E .)

Electrons and holes: the band picture

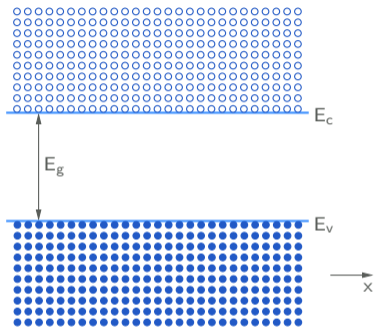


Filled and empty electron states at 0 K.

(Note: This is a schematic representation;
in reality, the density of states varies with E.)

- * At $T = 0$ K, the valence band is completely full of electrons, and the conduction band is completely empty.

Electrons and holes: the band picture

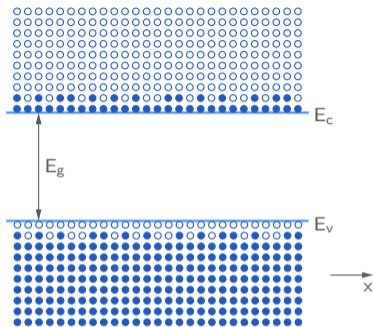


Filled and empty electron states at 0 K.

(Note: This is a schematic representation;
in reality, the density of states varies with E.)

- * At $T = 0$ K, the valence band is completely full of electrons, and the conduction band is completely empty.
- * There is no possibility of conduction.

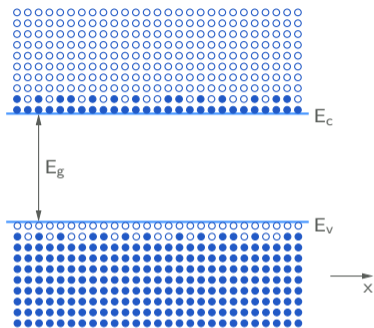
Electrons and holes: the band picture



Filled and empty electron states at 300 K.

(Note: This is a schematic representation;
in reality, the density of states varies with E.)

Electrons and holes: the band picture

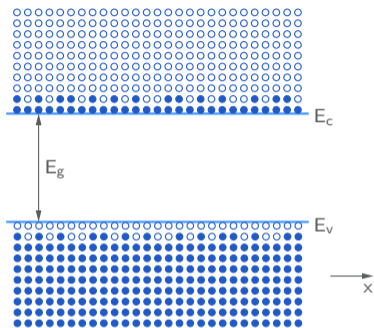


Filled and empty electron states at 300 K.

(Note: This is a schematic representation;
in reality, the density of states varies with E .)

- * As the lattice temperature is increased, the probability of occupation of conduction band states by electrons increases.

Electrons and holes: the band picture

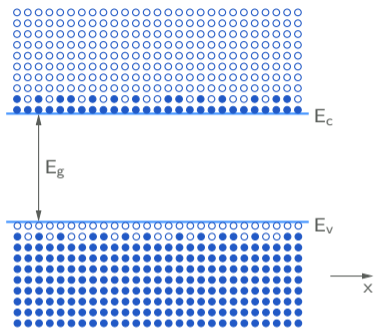


Filled and empty electron states at 300 K.

(Note: This is a schematic representation;
in reality, the density of states varies with E.)

- * As the lattice temperature is increased, the probability of occupation of conduction band states by electrons increases.
- * In a pure or “intrinsic” semiconductor, the number of electrons in the conduction band must be equal to the number of vacancies (holes) in the valence band.

Electrons and holes: the band picture

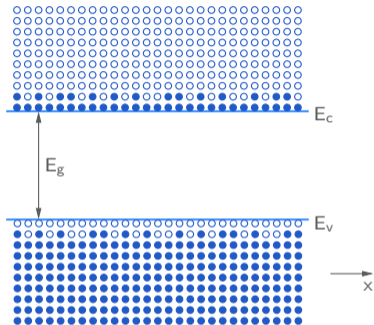


Filled and empty electron states at 300 K.

(Note: This is a schematic representation;
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- * As the lattice temperature is increased, the probability of occupation of conduction band states by electrons increases.
- * In a pure or “intrinsic” semiconductor, the number of electrons in the conduction band must be equal to the number of vacancies (holes) in the valence band.
- * The density of electrons (or holes) in the above situation is denoted by n_i , the “intrinsic carrier concentration,” and it is about 10^{10} cm^{-3} for Si at $T = 300 \text{ K}$. (Note that it is much smaller than the density of silicon atoms in the crystal, i.e., $5 \times 10^{22} \text{ cm}^{-3}$).

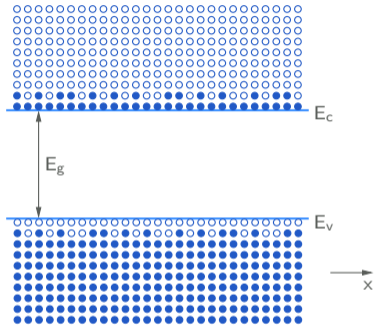
Electrons and holes: the band picture



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(Note: This is a schematic representation;
in reality, the density of states varies with E.)

Electrons and holes: the band picture

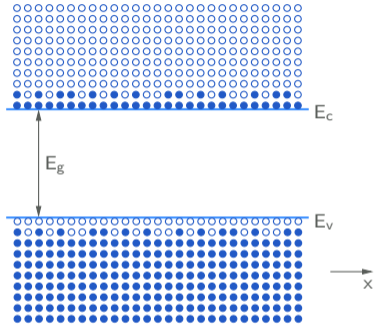


Filled and empty electron states at 300 K.

(Note: This is a schematic representation;
in reality, the density of states varies with E.)

- * An electron in the conduction band can move to one of the large number of empty states in the conduction band and contribute to a current.

Electrons and holes: the band picture

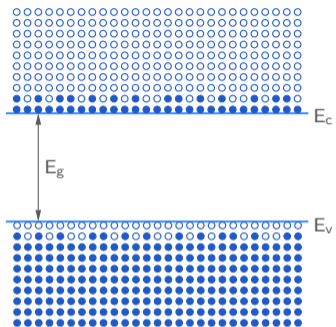


Filled and empty electron states at 300 K.

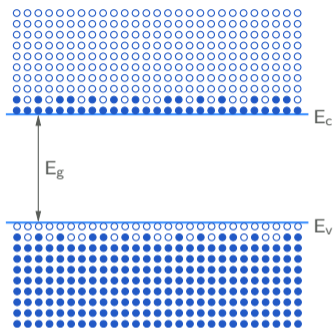
(Note: This is a schematic representation;
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- * An electron in the conduction band can move to one of the large number of empty states in the conduction band and contribute to a current.
- * Similarly, a hole in the valence band can move to one of the large number of filled states in the valence band and contribute to a current.

Electrons and holes: the band picture

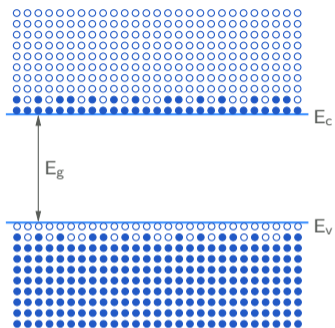


Electrons and holes: the band picture



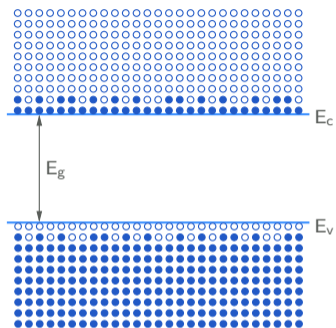
- * Filled states in the conduction band (the mobile electrons or simply “electrons”) and empty states in the valence band (the mobile vacancies or “holes”) are confined to a narrow energy range near E_c and E_v , respectively (~ 100 meV at 300 K).

Electrons and holes: the band picture



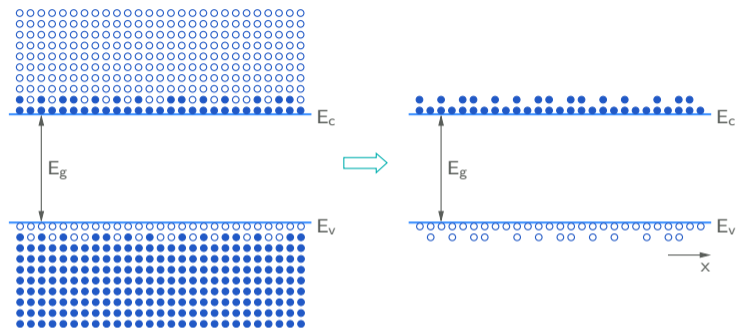
- * Filled states in the conduction band (the mobile electrons or simply “electrons”) and empty states in the valence band (the mobile vacancies or “holes”) are confined to a narrow energy range near E_c and E_v , respectively (~ 100 meV at 300 K).
- * The actual extent of the conduction or valence band does not affect the electron or hole statistics, and it is a common practice to show the conduction band extending to $+\infty$ and the valence band to $-\infty$.

Electrons and holes: the band picture



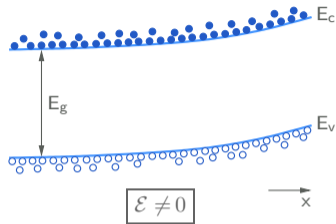
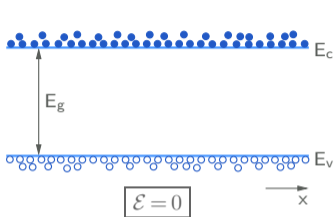
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- * For simplicity, we will not show vacant states in the conduction band, and filled states in the valence band.

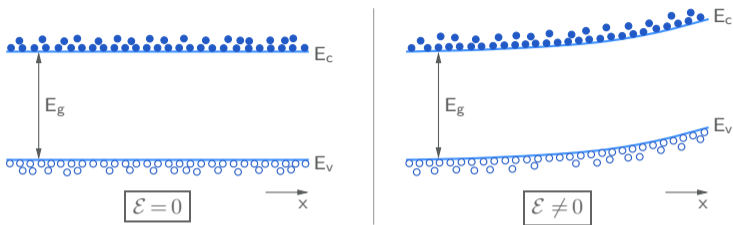
Electrons and holes: the band picture



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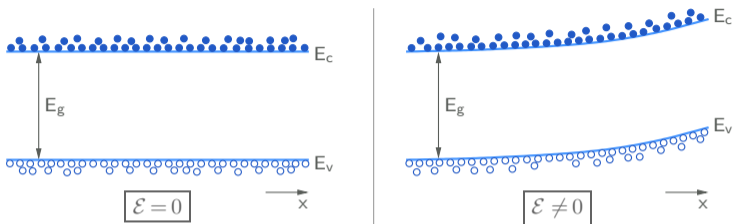
Effect of electric field



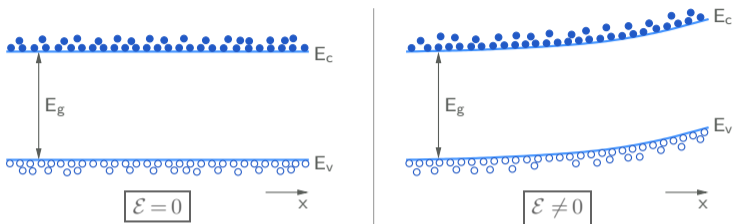


* If the electrostatic potential varies with space, it causes “band bending.”

Effect of electric field

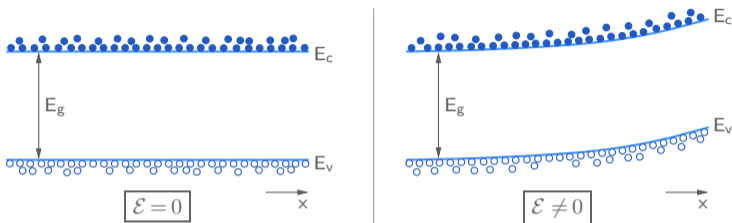


- * If the electrostatic potential varies with space, it causes “band bending.”
- * Since E_c and E_v refer to energy of an electron with a negative charge $-q$,
 $E_c(x) = -q\psi(x) + \text{constant}$, $E_v(x) = E_c(x) - E_g$.



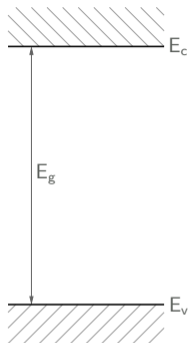
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- * The electric field and potential are related by $\mathcal{E} = -\frac{d\psi}{dx}$.

$$\rightarrow \mathcal{E} = \frac{1}{q} \frac{dE_c}{dx} = \frac{1}{q} \frac{dE_v}{dx}$$

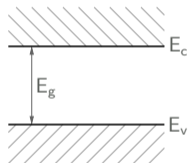


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 $\rightarrow \mathcal{E} = \frac{1}{q} \frac{dE_c}{dx} = \frac{1}{q} \frac{dE_v}{dx}$
- * The constant in the above equation is irrelevant because only differences such as $(E_c(x_1) - E_c(x_2))$ are important, and the constant drops out.

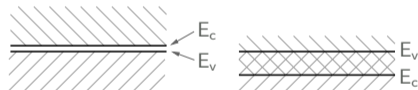
Energy gap and conductivity



Insulator



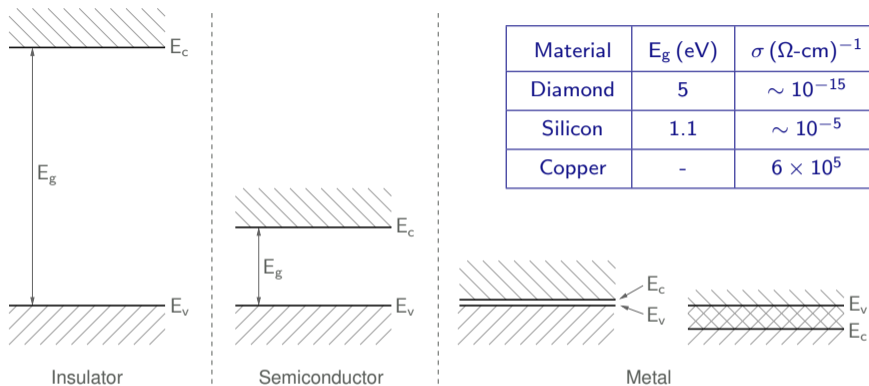
Semiconductor



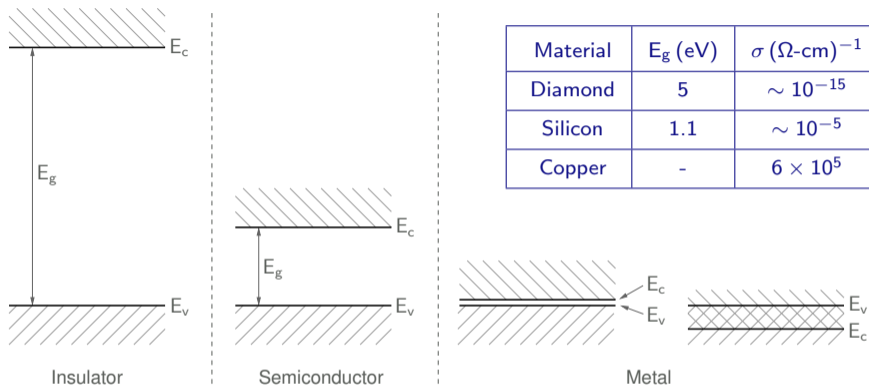
Metal

Material	E_g (eV)	σ ($\Omega\text{-cm}$) ⁻¹
Diamond	5	$\sim 10^{-15}$
Silicon	1.1	$\sim 10^{-5}$
Copper	-	6×10^5

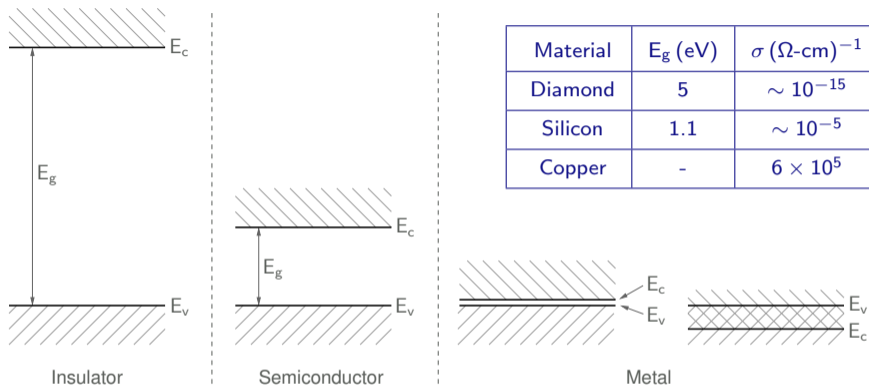
Energy gap and conductivity



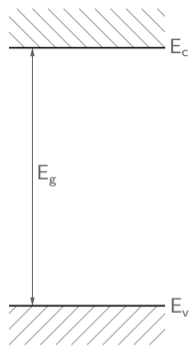
* The electrical conductivity of a crystalline material depends on its energy gap E_g .



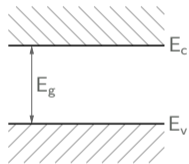
- * The electrical conductivity of a crystalline material depends on its energy gap E_g .
- * In an insulator, E_g is so large that there are no electrons (in the conduction band) or holes (in the valence band) at room temperature \rightarrow low conductivity.



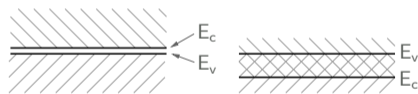
- * The electrical conductivity of a crystalline material depends on its energy gap E_g .
- * In an insulator, E_g is so large that there are no electrons (in the conduction band) or holes (in the valence band) at room temperature \rightarrow low conductivity.
- * In a metal, E_g is either very small or non-existent. As a result, electrons in the filled states can move to one of the large number of vacant states \rightarrow high conductivity.



Insulator

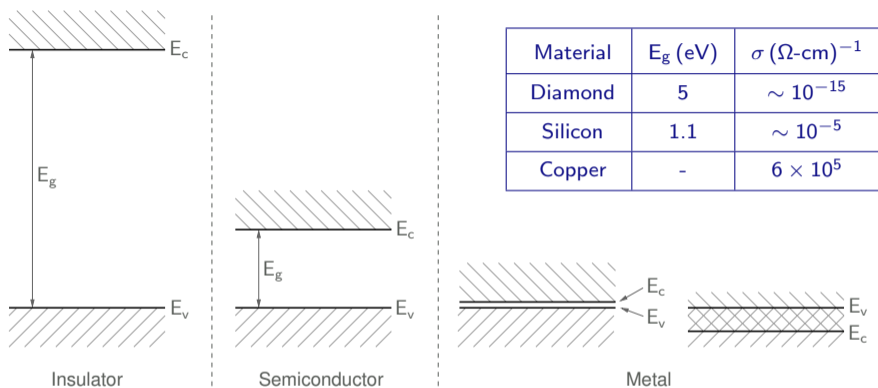


Semiconductor

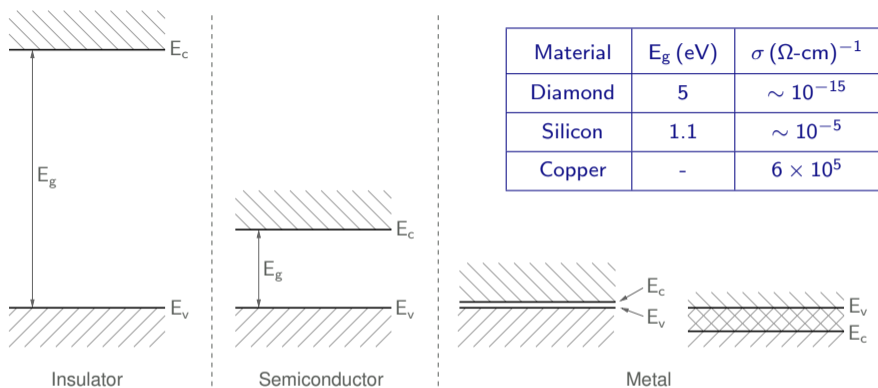


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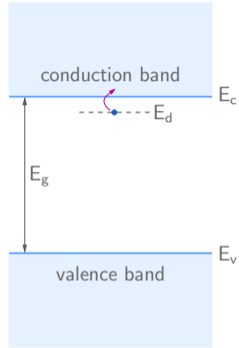
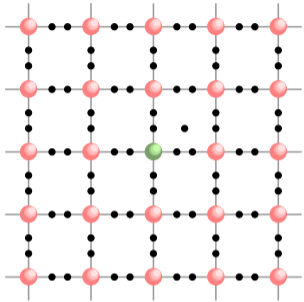


- * For a semiconductor, the situation is between these two extremes \rightarrow moderate conductivity.

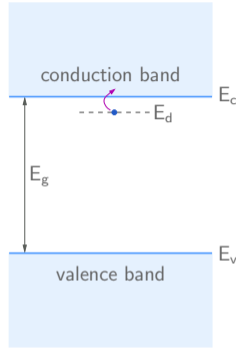
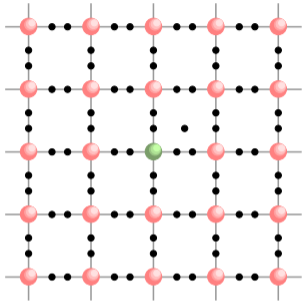


- * For a semiconductor, the situation is between these two extremes \rightarrow moderate conductivity.
- * Note that we have only looked at an “intrinsic” semiconductor. With addition of appropriate impurity (donor or acceptor) atoms, the conductivity of a semiconductor can be changed very significantly.

Band picture: effect of a donor atom

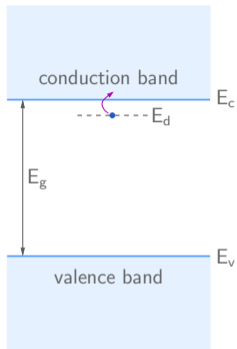
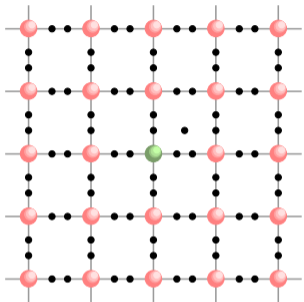


Band picture: effect of a donor atom



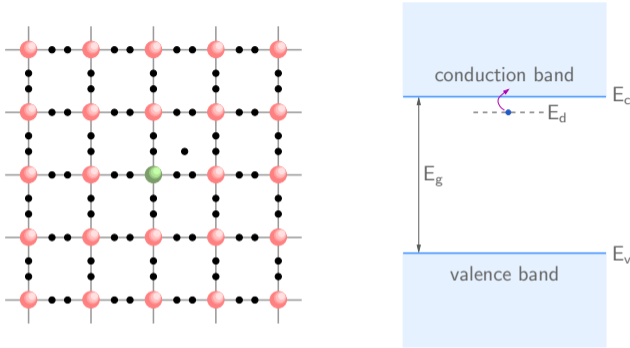
- * When a silicon atom is replaced with a donor (group V) atom, it introduces an energy level (state) in the forbidden gap, which is close to E_c .

Band picture: effect of a donor atom



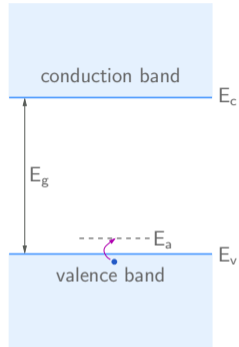
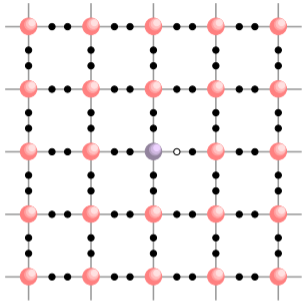
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- * At low temperatures, the donor state is occupied, i.e., the electron is bound to the donor atom.

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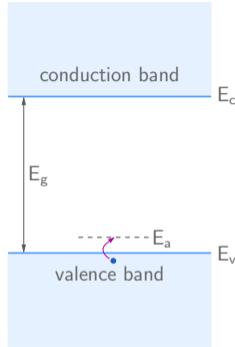
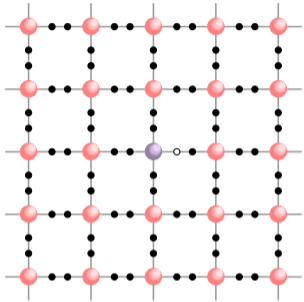


- * When a silicon atom is replaced with a donor (group V) atom, it introduces an energy level (state) in the forbidden gap, which is close to E_c .
- * At low temperatures, the donor state is occupied, i.e., the electron is bound to the donor atom.
- * At high temperatures, the electron can cross the energy barrier ($E_c - E_d$) and enter the conduction band.

Band picture: effect of an acceptor atom

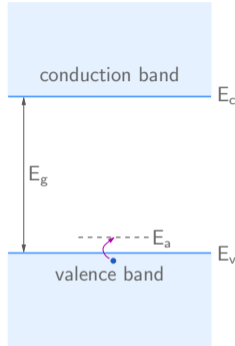
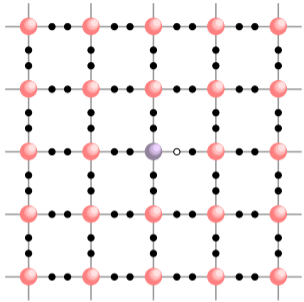


Band picture: effect of an acceptor atom



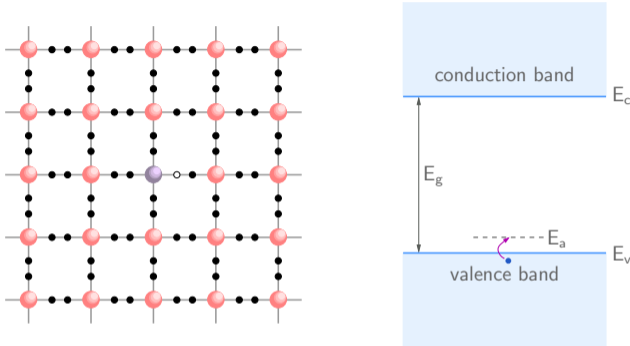
- * When a silicon atom is replaced with an acceptor (group III) atom, it introduces an energy level (state) in the forbidden gap, which is close to E_v .

Band picture: effect of an acceptor atom



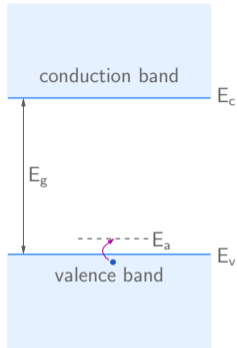
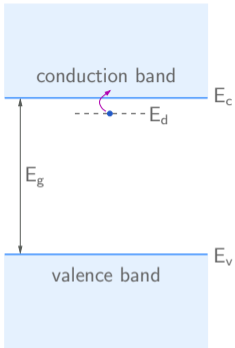
- * When a silicon atom is replaced with an acceptor (group III) atom, it introduces an energy level (state) in the forbidden gap, which is close to E_v .
- * At low temperatures, the acceptor state is empty, i.e., there is a vacancy around the acceptor atom.

Band picture: effect of an acceptor atom

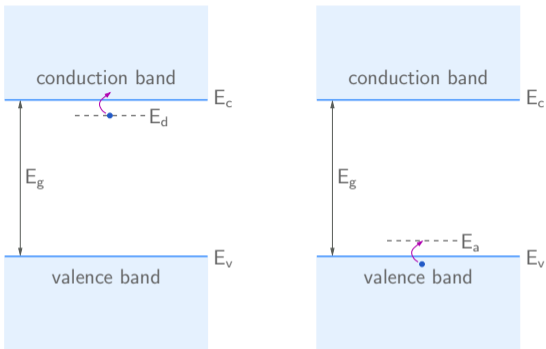


- * When a silicon atom is replaced with an acceptor (group III) atom, it introduces an energy level (state) in the forbidden gap, which is close to E_v .
- * At low temperatures, the acceptor state is empty, i.e., there is a vacancy around the acceptor atom.
- * At high temperatures, an electron from the valence band can cross the energy barrier ($E_a - E_v$), leaving a hole in the valence band.

Donor and acceptor levels

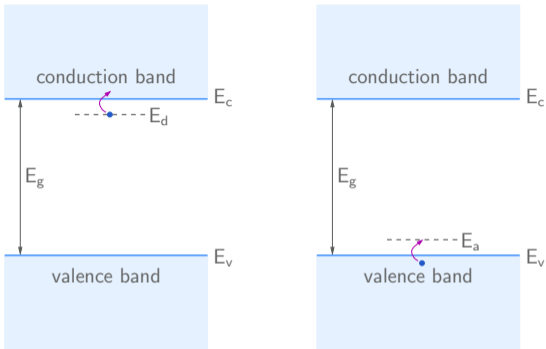


Donor and acceptor levels



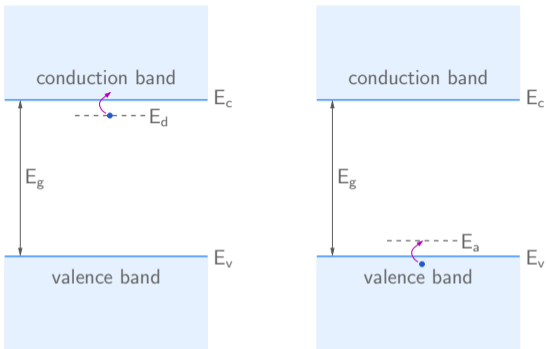
- * The effectiveness of a donor atom to contribute an electron depends on the binding energy $E_B = E_c - E_d$.

Donor and acceptor levels



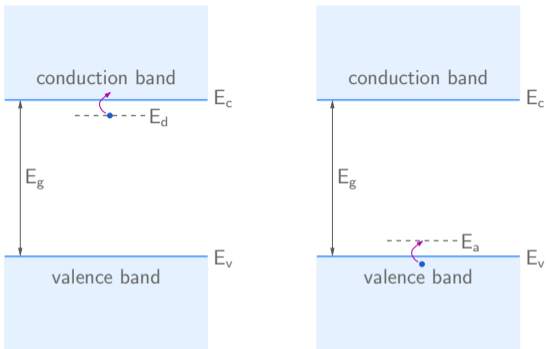
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Donor and acceptor levels



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- * For a “shallow” donor, this energy is typically a few tens of meV (45 meV for P and 54 meV for As in silicon).
- * Similarly, the effectiveness of an acceptor atom to contribute a hole depends on the binding energy $E_B = E_a - E_v$.
- * For a “shallow” acceptor, this energy is typically a few tens of meV (45 meV for B in silicon).